High Power LED Series 3535 Ceramic Hot Binning

LH351B



High efficacy and high quality color rendering makes the LH351B suitable use in a broad range of applications



Features & Benefits

- Operates at a maximum current of up to 1.5 A
- Uniform light distribution under any beam angle
- 80 CRI makes it well suited for most applications
- Hot binning @ 85 ºC
- Completed 10,000 hours of LM-80 testing @ 1 A, 105 ℃

Applications

- Indoor Lighting: Spotlight, Downlight
- Outdoor Lighting: Street Light, Tunnel Light, Security Light, Parking Lot Light
- Industrial Lighting: High Bay Light, Low Bay Light
- Consumer Lighting: Torch Light







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1. Characteristics

a) Absolute Maximum Rating

Item	Symbol	Rating	Unit	Condition
Operating Temperature	T_{opr}	-40 ~ +105	₆ C	Note 1)*
Storage Temperature	T_{stg}	-40 ~ +120	ōС	-
LED Junction Temperature	T _j	150	ōС	-
Forward Current	I_{F}	1500	mA	-
Peak Pulse Forward Current	I _{FP}	2000	mA	Duty 1/10 pulse width 10ms
Assembly Process Temperature		260 <10	s ©C	-
ESD (HBM)	-	±8	kV	-

Notes:

1) Refer to the derating curve, '3. Typical Characteristics Graph', for proper driving current that maintained below maximum junction temperature.

b) Electro-optical Characteristics

Itom	Unit	Nominal CCT	Cond	Condition		
ltem	Unit	(K)	I _F (mA)	T _j (°C)	Value Typ.	
			350	25	149	
			350	85	136	
		3000 (80 CRI)	700	85	249	
			1000	85	332	
Luminous Flux (Φ_{v})	lm		1500	85	446	
Eurimous Flux (Φ_v)	""		350	25	175	
		5000 (70 CRI)	350	85	160	
			700	85	292	
			1000	85	391	
			1500	85	525	
			350	25	2.86	
			350	85	2.75	
Forward Voltage $(V_{\rm F})$	V		700	85	2.89	
			1000	85	2.99	
			1500	85	3.12	
Reverse Voltage (@ 5 mA)	V		350	25	14~19.5	
Thermal Resistance (junction to solder point)	ºC/W		350	25	4	
Beam Angle	ō		350	25	120	

Notes:

- 1) Samsung maintains measurement tolerance of: luminous flux = ± 7 %, forward voltage = ± 0.1 V
- 2) Characteristics @ 25 °C are for reference only

c) Luminous Flux Characteristics $(T_j = 85 \text{ }^{\circ}\text{C})$

Nominal CCT	CRI (R _a)	Sorting @	350 mA (lm)	Calcula	ated Minimum Flu	(lm)
(K)	Min. ¹⁾	Flux Rank	Flux Min. ¹⁾	@ 700 mA	@ 1000 mA	@ 1500 m/
	70	J3	120	217	286	386
2200	70	(K3)	(132)	(238)	(314)	(424)
2200	80	G3	100	181	238	322
	80	(H3)	(110)	(199)	(262)	(353)
		K3	130	235	310	418
		(M3)	(143)	(258)	(340)	(460)
	70	M3	140	252	335	457
	70	(N3)	(153)	(276)	(366)	(499)
		N3	150	270	359	489
		(P3)	(164)	(295)	(392)	(534)
2700		J3	120	217	286	386
2700	80	(K3)	(132)	(238)	(314)	(424)
	80	К3	130	235	310	418
		(M3)	(143)	(258)	(340)	(460)
		F3	90	163	214	289
	90	(G3)	(99)	(179)	(236)	(318)
		G3	100	181	238	322
		(H3)	(110)	(199)	(262)	(353)
		M3	140	252	335	457
	70	(N3)	(153)	(276)	(366)	(499)
	70	N3	150	270	359	489
		(P3)	(164)	(295)	(392)	(534)
***		J3	120	217	286	386
		(K3)	(132)	(238)	(314)	(424)
2000		K3	130	234	311	424
3000	80	(M3)	(142)	(256)	(340)	(463)
		M3	140	252	335	457
		(N3)	(153)	(276)	(366)	(499)
		G3	100	181	238	322
	00	(H3)	(110)	(199)	(262)	(353)
	90	H3	110	199	262	354
		(J3)	(121)	(218)	(288)	(389)
		K3	130	234	311	424
		(M3)	(142)	(256)	(340)	(463)
		M3	140	252	335	457
	70	(N3)	(153)	(276)	(366)	(499)
		N3	150	270	359	489
		(P3)	(164)	(295)	(392)	(534)
2500		K3	130	234	311	424
3500		(M3)	(142)	(256)	(340)	(463)
	80	M3	140	252	335	457
		(N3)	(153)	(276)	(366)	(499)
		G3	100	181	238	322
		(H3)	(110)	(199)	(262)	(353)
	90	H3	110	199	262	354
		(J3)	(121)	(218)	(288)	(389)

(value in bracket): Minimum luminous flux @ 25 °C, for reference only

Notes:

- 1) Samsung maintains measurement tolerance of: luminous flux = ± 7 %, CRI = ± 3
- 2) Calculated minimum flux values are for reference only

c) Luminous Flux Characteristics $(T_j = 85 \text{ }^{\circ}\text{C})$

Nominal CCT	CRI (Ra)	Sorting @	Sorting @ 350 mA (lm)		Calculated Minimum Flux ²⁾ (lm)			
(K)	Min. ¹⁾	Flux Rank	Flux Min. ¹⁾	@ 700 mA	@ 1000 mA	@ 1500 mA		
		N3	150	270	359	489		
	70	(P3)	(164)	(295)	(392)	(534)		
	70	P3	160	288	382	518		
		(Q3)	(174)	(312)	(415)	(562)		
4000		К3	130	235	310	418		
4000	80	(M3)	(143)	(258)	(340)	(460)		
	80	M3	140	252	335	457		
		(N3)	(153)	(276)	(366)	(499)		
	90	J3	120	217	286	386		
		(K3)	(132)	(238)	(314)	(424)		
		M3	140	252	335	457		
		(N3)	(153)	(276)	(366)	(499)		
		N3	150	270	359	489		
	70	(P3)	(164)	(295)	(392)	(534)		
		P3	160	288	382	518		
		(Q3)	(174)	(312)	(415)	(562)		
5000		Q2	170	306	405	545		
5000		(R2)	(184)	(329)	(437)	(590)		
		M3	140	252	335	457		
	90	(N3)	(153)	(276)	(366)	(499)		
	80	N3	150	270	359	489		
		(P3)	(164)	(295)	(392)	(534)		
	90	K3	130	234	311	424		
		(M3)	(142)	(256)	(340)	(463)		
		N3	150	270	359	489		
	70	(P3)	(164)	(295)	(392)	(534)		
5700	70	P3	160	288	382	518		
5700		(Q3)	(174)	(312)	(415)	(562)		
		M3	140	252	335	457		
	80	(N3)	(153)	(276)	(366)	(499)		
		K3	130	234	311	424		
cook	00	(M3)	(142)	(256)	(340)	(463)		
6000K	80	M3	140	252	335	457		
		(N3)	(153)	(276)	(366)	(499)		
		N3	150	270	359	489		
	70	(P3)	(164)	(295)	(392)	(534)		
	70	P3	160	288	382	518		
6563		(Q3)	(174)	(312)	(415)	(562)		
6500		K3	130	234	311	424		
		(M3)	(142)	(256)	(340)	(463)		
	80	M3	140	252	335	457		
		(N3)	(153)	(276)	(366)	(499)		

(value in bracket): Minimum luminous flux @ 25 °C, for reference only

Notes:

1) Samsung maintains measurement tolerance of: luminous flux = ± 7 %, CRI = ± 3

2) Calculated minimum flux values are for reference only

2. Product Code Information

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
S	Р	н	w	н	2	L	3	D	3	0	F	D	4	V	0	К	3

Digit	PKG Information	Code	Specification		
1 2 3	Samsung Package High Power	SPH			
4 5	Color	WH	White		
6	Product Version	2			
7 8	Product	L3	LH351 Series		
9	Lens Type	D	Dome lens		
10	Internal Code	3			
11	Not Defined	0	Default		
		С	Min. 70		
		D	Min. 75		
12	CRI & Sorting Temperature	E	Min. 80 85 ℃		
		F	Min. 85		
		G	Min. 90		
13 14	Forward Voltage (V)	D 4	2.5~3.0 Bin D2 2.5~2.8		
15 14	Forward voitage (v)	D4	Code: F2 2.8~3.0		
			2200 Y1, Y2, Y3, Y4, Y5, Y6, Y7, Y8, Y9, YA, YB, YC, YD, YE, YF, YG, YM		
		w☆	2700 W1, W2, W3, W4, W5, W6, W7, W8, W9, WA, WB, WC, WD, WE, WF, WG, WM		
		V☆	3000 V1, V2, V3, V4, V5, V6, V7, V8, V9, VA, VB, VC, VD, VE, VF, VG, VM		
		U☆	3500 U1, U2, U3, U4, U5, U6, U7, U8, U9, UA, UB, UC, UD, UE, UF, UG, UM		
	CCT (K)	T☆	4000 Bin T1, T2, T3, T4, T5, T6, T7, T8, T9, TA, TB, TC, TD, TE, TF, TG, TM		
15 16	CCT (K)	R ♦	5000 Code: R1, R2, R3, R4		
		Q¢	5700 Q1, Q2, Q3, Q4		
		PQ	6000 P2, Q1, P4, Q3		
		P ♦	6500 P1, P2, P3, P4		
			☆: "0" (Whole bin), "P" (Quarter bin), or "M" (MacAdam 3-step ellipse bin) ◇: "T" (Half bin), or "N" (MacAdam 5-step ellipse bin)		
		F3	90~120 F1 90~100		
		G 3	100~130 G1 100~110 F3		
		Н3	110~140 H1 110~120 G3		
		J 3	120~150 J1 120~130 H3		
		К 3	130~160 K1 130~140 J3		
		M 3	140~170 M1 140~150 K3		
17 18	Luminous Flux (Im)	N 3	150~180 N1 150~160 M3		
		Р3	160-190 P1 160~170 N3		
		Q2	170-190 Q1 170~180		
			R1 180-190		
		Digit 1	7: Min. spec.		
			8: The number of higher bin(s) from min. spec.		
			K1 = 130~140 lm, K3 = 130~160 lm		
		c.g N1 - 130 140 IIII, N3 - 130 100 IIII			

a) Luminous Flux Bins ($I_F = 350 \text{ mA}, T_j = 85 \text{ }^{\circ}\text{C}$)

Nominal CCT (K)	CRI (R₃) Min.	Product Code	Flux Rank	Flux Bin	Flux Range (Φ _v , lm)
				J1	120 ~ 130
	70	SPHWH2L3D30CD4Y☆J3	J3	K1	130 ~ 140
2200	·····		•••	M1	140 ~ 150
2200				G1	100 ~ 110
	80	SPHWH2L3D30ED4Y☆G3	G3	H1	110 ~ 120
				J1	120 ~ 130
				K1	130 ~ 140
		SPHWH2L3D30CD4W ☆ K3	К3	M1	140 ~ 150
				N1	150 ~ 160
				M1	140 ~ 150
	70	SPHWH2L3D30CD4W ☆ M3	M3 .	N1	150 ~ 160
				P1	160 ~ 170
				N1	150 ~ 160
		SPHWH2L3D30CD4W☆N3	N3	P1	160 ~ 170
				Q1	170 ~ 180
			J3	J1	120 ~ 130
2700		SPHWH2L3D30ED4W ☆J3		K1	130 ~ 140
	80			M1	140 ~ 150
	00			K1	130 ~ 140
		SPHWH2L3D30ED4W ☆ K3	К3	M1	140 ~ 150
				N1	150 ~ 160
		SPHWH2L3D30GD4W☆F3		F1	90 ~ 100
	90		F3	G1	100 ~ 110
				H1	110 ~ 120
				G1	100 ~ 110
		SPHWH2L3D30GD4W ☆G3	G3	H1	110 ~ 120
				J1	120 ~ 130
				M1	140 ~ 150
		SPHWH2L3D30CD4V☆M3	M3	N1	150 ~ 160
				P1	160 ~ 170
	70			N1	150 ~ 160
		SPHWH2L3D30CD4V☆N3	N3	P1	160 ~ 170
		5	.10	Q1	170 ~ 180
					120 ~ 130
3000		SPHWH2L3D30ED4V ☆J3	J3	K1	130 ~ 140
3000		SELLANUSTED 20ED 44 № 12		M1	140 ~ 150
	90	CDUM/U212D20ED 4V-A-K2	V2	K1	130 ~ 140
	80	SPHWH2L3D30ED4V ☆ K3	K3	M1	140 ~ 150
				N1	150 ~ 160
			M3 .	M1	140 ~ 150
		SPHWH2L3D30ED4V ☆ M3		N1	150 ~ 160
				P1	160 ~ 170

[&]quot;♦" can be "T" (Half bin), or "N" (MacAdam 5-step ellipse bin) of the color binning

a) Luminous Flux Bins ($I_F = 350 \text{ mA}, T_j = 85 \text{ }^{\circ}\text{C}$)

Nominal CCT (K)	CRI (R _a) Min.	Product Code	Flux Rank	Flux Bin	Flux Range (Φ _v , lm)
				G1	100 ~ 110
		SPHWH2L3D30GD4V☆G3	G3	H1	110 ~ 120
3000	90			J1	120 ~ 130
3000	90			H1	110 ~ 120
		SPHWH2L3D30GD4V ☆ H3	H3	J1	120 ~ 130
				K1	130 ~ 140
				K1	130 ~ 140
		SPHWH2L3D30CD4U ☆ K3	К3	M1	140 ~ 150
				N1	150 ~ 160
				M1	140 ~ 150
	70	SPHWH2L3D30CD4U ☆ M3	M3	N1	150 ~ 160
				P1	160 ~ 170
	****			N1	150 ~ 160
		SPHWH2L3D30CD4U ☆ N3	N3	P1	160 ~ 170
				Q1	170 ~ 180
•••				K1	130 ~ 140
3500		SPHWH2L3D30ED4U ☆ K3	K3	M1	140 ~ 150
		SPHWH2L3D30ED4U☆M3 M3		N1	150 ~ 160
	80			M1	140 ~ 150
				N1	150 ~ 160
				P1	160 ~ 170
•••				G1	100 ~ 110
		SPHWH2L3D30GD4U☆G3	G3	H1	110 ~ 120
				J1	120 ~ 130
	90			H1	110 ~ 120
		SPHWH2L3D30GD4U☆H3	H3	J1	120 ~ 130
		2		K1	130 ~ 140
				N1	150 ~ 160
		SPHWH2L3D30CD4T☆N3	N3	P1	160 ~ 170
		SPHWH2L3D30CD41 RN3	143	Q1	170 ~ 180
4000	70			P1	160 ~ 170
		CDHIWITH SUSOCUAT 1/2 DS	Р3	Q1	
		SPHWH2L3D30CD4T☆P3			170 ~ 180
				R1	180 ~ 190

[&]quot;

"
" can be "0" (Whole bin), "P" (Quarter bin), or "M" (MacAdam 3-step ellipse bin) of the color binning

[&]quot; \diamond " can be "T" (Half bin), or "N" (MacAdam 5-step ellipse bin) of the color binning

a) Luminous Flux Bins ($I_F = 350$ mA, $T_j = 85$ °C)

Nominal CCT (K)	CRI (R _a) Min.	Product Code	Flux Rank	Flux Bin	Flux Range (Φ _v , lm)
				K1	130 ~ 140
		SPHWH2L3D30ED4T☆K3	К3	M1	140 ~ 150
	80			N1	150 ~ 160
	80 "			M1	140 ~ 150
		SPHWH2L3D30ED4T☆M3	M3	N1	150 ~ 160
4000				P1	160 ~ 170
4000				J1	120 ~ 130
		SPHWH2L3D30GD4T0J3	J3	K1	130 ~ 140
	90			M1	140 ~ 150
	90			J1	120 ~ 130
		SPHWH2L3D30GD4TPJ3	J3	K1	130 ~ 140
				M1	140 ~ 150
		SPHWH2L3D30CD4R \diamondsuit M3 M3		M1	140 ~ 150
			M3	N1	150 ~ 160
				P1	160 ~ 170
				N1	150 ~ 160
		SPHWH2L3D30CD4R \diamondsuit N3	N3	P1	160 ~ 170
	70			Q1	170 ~ 180
				P1	160 ~ 170
		SPHWH2L3D30CD4R \diamondsuit P3	P3	Q1	170 ~ 180
				R1	180 ~ 190
5000	••		0.2	Q1	170 ~ 180
5000		SPHWH2L3D30CD4R \diamondsuit Q2	Q2	R1	180 ~ 190
•••				M1	140 ~ 150
		SPHWH2L3D30ED4R \diamondsuit M3	M3	N1	150 ~ 160
				P1	160 ~ 170
	80			N1	150 ~ 160
		SPHWH2L3D30ED4R♦N3	N3	P1	160 ~ 170
				Q1	170 ~ 180
				K1	130 ~ 140
	90	SPHWH2L3D30GD4R \diamondsuit K3	K3	M1	140 ~ 150
				N1	150 ~ 160

[&]quot;

"
" can be "0" (Whole bin), "P" (Quarter bin), or "M" (MacAdam 3-step ellipse bin) of the color binning

[&]quot; \diamond " can be "T" (Half bin), or "N" (MacAdam 5-step ellipse bin) of the color binning

a) Luminous Flux Bins ($I_F = 350 \text{ mA}, T_j = 85 \text{ }^{\circ}\text{C}$)

Nominal CCT (K)	CRI (R _a) Min.	Product Code	Flux Rank	Flux Bin	Flux Range (Φ _v , lm)
				N1	150 ~ 160
		SPHWH2L3D30CD4Q \diamondsuit N3	N3	P1	160 ~ 170
	70			Q1	170 ~ 180
	70			P1	160 ~ 170
5700		SPHWH2L3D30CD4Q♦P3 P3	P3	Q1	170 ~ 180
				R1	180 ~ 190
				M1	140 ~ 150
	80	SPHWH2L3D30ED4Q \diamondsuit M3	M3	N1	150 ~ 160
				P1	160 ~ 170
			K1	130 ~ 140	
		SPHWH2L3D30ED4PQK3	К3	M1	140 ~ 150
6000	80			N1	150 ~ 160
0000	00			M1	140 ~ 150
		SPHWH2L3D30ED4PQM3	M3	N1	150 ~ 160
				P1	160 ~ 170
				N1	150 ~ 160
		SPHWH2L3D30CD4P \diamondsuit N3	N3	P1	160 ~ 170
	70			Q1	170 ~ 180
	70			P1	160 ~ 170
		SPHWH2L3D30CD4P \diamondsuit P3	P3	Q1	170 ~ 180
6500				R1	180 ~ 190
0300				K1	130 ~ 140
		SPHWH2L3D30ED4P◇K3	К3	M1	140 ~ 150
	80			N1	150 ~ 160
	ou	80		M1	140 ~ 150
		SPHWH2L3D30ED4P \diamondsuit M3	M3	N1	150 ~ 160
				P1	160 ~ 170

[&]quot; \propto " can be "0" (Whole bin), "P" (Quarter bin), or "M" (MacAdam 3-step ellipse bin) of the color binning

[&]quot; \diamond " can be "T" (Half bin), or "N" (MacAdam 5-step ellipse bin) of the color binning

b) Color Bins ($I_F = 350 \text{ mA}, T_j = 85 \text{ }^{\circ}\text{C}$)

Nominal CCT (K)	CRI (R _a) Min.	Product Code	Color Rank	Chromaticity Bins	
		SPHWH2L3D30ED4Y0J3	Y0 (Whole bin)	Y1, Y2, Y3, Y4, Y5, Y6, Y7, Y8, Y9, YA, YB, YC, YD, YE, YF, YG	
	70	SPHWH2L3D30ED4YPJ3	YP (Quarter bin)	Y6, Y7, YA, YB	
2200		SPHWH2L3D30ED4YMJ3	YM (MacAdam 3-step)	YM	
2200		SPHWH2L3D30ED4Y0G3	Y0 (Whole bin)	Y1, Y2, Y3, Y4, Y5, Y6, Y7, Y8, Y9, YA, YB, YC, YD, YE, YF, YG	
	80	SPHWH2L3D30ED4YPG3	YP (Quarter bin)	Y6, Y7, YA, YB	
		SPHWH2L3D30ED4YMG3	YM (MacAdam 3-step)	YM	
		SPHWH2L3D30CD4W0K3	W0	NA/4 NA/2 NA/2 NA/4 NA/5 NA/5 NA/7 NA/9	
		SPHWH2L3D30CD4W0M3	(Whole bin)	W1, W2, W3, W4, W5, W6, W7, W8, W9, WA, WB, WC, WD, WE, WF, WG	
		SPHWH2L3D30CD4W0N3	,	-, , , , , , , , ,	
		SPHWH2L3D30CD4WPK3	WP		
	70	SPHWH2L3D30CD4WPM3	(Quarter bin)	W6, W7, WA, WB	
		SPHWH2L3D30CD4WPN3	(
		SPHWH2L3D30CD4WMK3	WM		
		SPHWH2L3D30CD4WMM3	(MacAdam 3-step)	WM	
		SPHWH2L3D30CD4WMN3	, , , , , , , , , , , , , , , , , , , ,		
		SPHWH2L3D30ED4W0J3	····· W0 (Whole bin)	W1, W2, W3, W4, W5, W6, W7, W8,	
2700		SPHWH2L3D30ED4W0K3		W9, WA, WB, WC, WD, WE, WF, WG	
	80	SPHWH2L3D30ED4WPJ3		W6, W7, WA, WB	
		SPHWH2L3D30ED4WPK3	(Quarter bin)		
	*****	SPHWH2L3D30ED4WMJ3	WM	WM	
		SPHWH2L3D30ED4WMK3	(MacAdam 3-step)		
		SPHWH2L3D30GD4W0F3	W0 (Whole bin)	W1, W2, W3, W4, W5, W6, W7, W8,	
		SPHWH2L3D30GD4W0G3	,	W9, WA, WB, WC, WD, WE, WF, WG	
	90	SPHWH2L3D30GD4WPF3	WP	W6, W7, WA, WB	
		SPHWH2L3D30GD4WPG3	(Quarter bin)		
		SPHWH2L3D30GD4WMF3	WM	WM	
		SPHWH2L3D30GD4WMG3	(MacAdam 3-step)		
		SPHWH2L3D30CD4V0M3	V0	V1, V2, V3, V4, V5, V6, V7, V8,	
		SPHWH2L3D30CD4V0N3	(Whole bin)	V9, VA, VB, VC, VD, VE, VF, VG	
	70	SPHWH2L3D30CD4VPM3	VP	V6, V7, VA, VB	
		SPHWH2L3D30CD4VPN3	(Quarter bin)		
		SPHWH2L3D30CD4VMM3	VM (MacAdam 3-step)	VM	
		SPHWH2L3D30CD4VMN3	(Infactional) 3-215h)		
3000		SPHWH2L3D30ED4V0J3	V0	V1, V2, V3, V4, V5, V6, V7, V8,	
3000		SPHWH2L3D30ED4V0K3	(Whole bin)	V9, VA, VB, VC, VD, VE, VF, VG	
		SPHWH2L3D30ED4V0M3			
	80	SPHWH2L3D30ED4VPJ3 SPHWH2L3D30ED4VPK3	VP	V6, V7, VA, VB	
			(Quarter bin)	vo, v,, vA, vb	
		SPHWH2L3D30ED4VPM3			
		SPHWH2L3D30ED4VMJ3 SPHWH2L3D30ED4VMK3	VM	VM	
			(MacAdam 3-step)	V IVI	
		SPHWH2L3D30ED4VMM3			

b) Color Bins $(I_F = 350 \text{ mA}, T_j = 85 \text{ }^{\circ}\text{C})$

Nominal CCT (K)	CRI (Ra) Min.	Product Code	Color Rank	Chromaticity Bins
		SPHWH2L3D30GD4V0G3	VO	V1, V2, V3, V4, V5, V6, V7, V8,
	*****	SPHWH2L3D30GD4V0H3	(Whole bin)	V9, VA, VB, VC, VD, VE, VF, VG
3000	90	SPHWH2L3D30GD4VPG3	VP	VC V7 VA VD
3000	90	SPHWH2L3D30GD4VPH3	(Quarter bin)	V6, V7, VA, VB
		SPHWH2L3D30GD4VMG3	VM	VM
		SPHWH2L3D30GD4VMH3	(MacAdam 3-step)	VM
	······	SPHWH2L3D30CD4U0K3		
	•••••	SPHWH2L3D30CD4U0M3	U0 (Whole bin)	U1, U2, U3, U4, U5, U6, U7, U8, U9, UA, UB, UC, UD, UE, UF, UG
	*****	SPHWH2L3D30CD4U0N3	(Whole Sill)	03, 04, 08, 00, 00, 01, 01
		SPHWH2L3D30CD4UPK3		
	70	SPHWH2L3D30CD4UPM3	······ UP	U6, U7, UA, UB
	*****	SPHWH2L3D30CD4UPN3	(Quarter bin)	
	*****	SPHWH2L3D30CD4UMK3		
	*****	SPHWH2L3D30CD4UMM3	UM	UM
	*****	SPHWH2L3D30CD4UMN3	(MacAdam 3-step)	
•••		SPHWH2L3D30ED4U0K3	U0	U1, U2, U3, U4, U5, U6, U7, U8,
3500	*****	SPHWH2L3D30ED4U0M3	(Whole bin)	U9, UA, UB, UC, UD, UE, UF, UG
	*****	SPHWH2L3D30ED4UPK3	UP	
	80	SPHWH2L3D30ED4UPM3	(Quarter bin)	U6, U7, UA, UB
	••••	SPHWH2L3D30ED4UMK3	UM	
	••••	SPHWH2L3D30ED4UMM3	(MacAdam 3-step)	UM
		SPHWH2L3D30GD4U0G3	 (Whole bin)	U1, U2, U3, U4, U5, U6, U7, U8,
		SPHWH2L3D30GD4U0H3		U9, UA, UB, UC, UD, UE, UF, UG
		SPHWH2L3D30GD4UPG3	UP	
	90	SPHWH2L3D30GD4UPH3	(Quarter bin)	U6, U7, UA, UB
		SPHWH2L3D30GD4UMG3	UM	
	•	SPHWH2L3D30GD4UMH3	(MacAdam 3-step)	UM
		SPHWH2L3D30CD4T0N3	TO	T1, T2, T3, T4, T5, T6, T7, T8,
	•	SPHWH2L3D30CD4T0P3	(Whole bin)	T9, TA, TB, TC, TD, TE, TF, TG
	*****	SPHWH2L3D30CD4TPN3	TP	
	70	SPHWH2L3D30CD4TPP3	(Quarter bin)	T6, T7, TA, TB
	••••	SPHWH2L3D30CD4TMN3	TM	
	*****	SPHWH2L3D30CD4TMP3	(MacAdam 3-step)	TM
		SPHWH2L3D30ED4T0K3	TO	T1, T2, T3, T4, T5, T6, T7, T8,
4000		SPHWH2L3D30ED4T0M3	(Whole bin)	T9, TA, TB, TC, TD, TE, TF, TG
		SPHWH2L3D30ED4TPK3	TP	
	80	SPHWH2L3D30ED4TPM3	(Quarter bin)	T6, T7, TA, TB
		SPHWH2L3D30ED4TMK3	TM	
		SPHWH2L3D30ED4TMM3	(MacAdam 3-step)	TM
		SPHWH2L3D30GD4T0J3	T0 (Whole bin)	T1, T2, T3, T4, T5, T6, T7, T8, T9, TA, TB, TC, TD, TE, TF, TG
	90	SPHWH2L3D30GD4TPJ3	TP (Quarter bin)	T6, T7, TA, TB

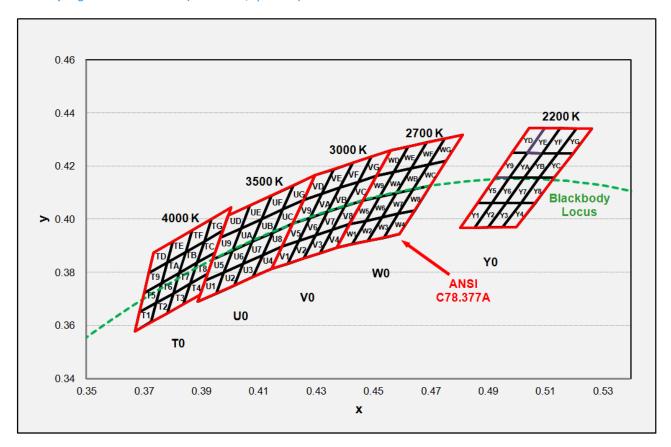
b) Color Bins ($I_F = 350 \text{ mA}, T_j = 85 \text{ }^{\circ}\text{C}$)

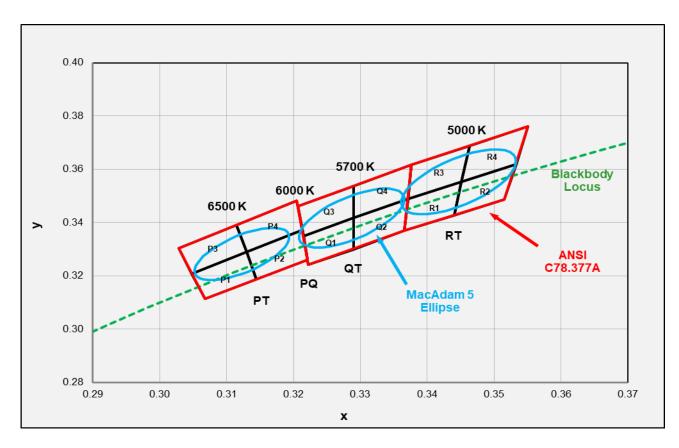
Nominal CCT (K)	CRI (R _a) Min.	Product Code	Color Rank	Chromaticity Bins	
		SPHWH2L3D30CD4RTM3			
	****	SPHWH2L3D30CD4RTN3	RT	04 03 03 04	
	••••	SPHWH2L3D30CD4RTP3	(Half bin)	R1, R2, R3, R4	
	70	SPHWH2L3D30CD4RTQ2			
	70	SPHWH2L3D30CD4RNM3			
		SPHWH2L3D30CD4RNN3	RN	DN	
	••••	SPHWH2L3D30CD4RNP3	(MacAdam 5-step)	RN	
5000					
•••		SPHWH2L3D30ED4RTM3	RT	04 03 03 04	
		SPHWH2L3D30ED4RTN3	(Half bin)	R1, R2, R3, R4	
	80	SPHWH2L3D30ED4RNM3	RN	201	
	••••	SPHWH2L3D30ED4RNN3	(MacAdam 5-step)	RN	
	00	SPHWH2L3D30GD4RTK3	RT (Half bin)	R1, R2, R3, R4	
	90	SPHWH2L3D30GD4RNK3	RN (MacAdam 5-step)	RN	
		SPHWH2L3D30CD4QTN3	QT		
		SPHWH2L3D30CD4QTP3	(Half bin)	Q1, Q2, Q3, Q4	
	70	SPHWH2L3D30CD4QNN3	QN	- CN	
5700	****	SPHWH2L3D30CD4QNP3	(MacAdam 5-step)	QN	
	80	SPHWH2L3D30ED4QTM3	QT (Half bin)	Q1, Q2, Q3, Q4	
	80	SPHWH2L3D30ED4QNM3	QN (MacAdam 5-step)	QN	
6000	80	SPHWH2L3D30ED4PQK3	PQ	Q1, Q3, P2, P4	
	60	SPHWH2L3D30ED4PQM3	(Half bin)	Q1, Q3, F2, F4	
		SPHWH2L3D30CD4PTN3	PT	P1, P2, P3, P4	
		SPHWH2L3D30CD4PTP3	(Half bin)	F1, F2, F3, F4	
	70	SPHWH2L3D30CD4PNN3	PN		
6500		SPHWH2L3D30CD4PNP3	(MacAdam 5-step)	PN	
		SPHWH2L3D30ED4PTK3	PT	P1, P2, P3, P4	
	90	SPHWH2L3D30ED4PTM3	(Half bin)	P1, P2, P3, P4	
	80	SPHWH2L3D30ED4PNK3	PN		
	****	SPHWH2L3D30ED4PNM3	(MacAdam 5-step)	PN	

c) Voltage Bins ($I_F = 350 \text{ mA}$, $T_j = 85 \text{ }^{\circ}\text{C}$)

Nominal CCT (K)	CRI (R₃) Min.	Product Code	Voltage Rank	Voltage Bin	Voltage Range (V)
_	_	_	D4 -	D2	2.5 ~ 2.8
-	-	-	D4 -	F2	2.8 ~ 3.0

d) Chromaticity Region & Coordinates (I_F = 350 mA, T_j = 85 $^{\circ}$ C)





d) Chromaticity Region & Coordinates (I $_F$ = 350 mA, T_j = 85 $^{\circ}$ C)

Region	CIE x	CIE y	Region	CIE x	CIE y
Y rank (2200 K)					
	0.4805	0.3968		0.4925	0.4156
V4	0.4854	0.3968	VO.	0.4976	0.4156
Y1	0.4915	0.4062	Y9	0.5038	0.4250
	0.4865	0.4062		0.4984	0.4250
	0.4854	0.3968		0.4976	0.4156
V2	0.4903	0.3969	VA	0.5028	0.4156
Y2	0.4966	0.4062	YA	0.5091	0.4249
	0.4915	0.4062	10 10 10 10 10 10 10 10 10 10 10 10 10 1	0.5038	0.4250
	0.4903	0.3969		0.5028	0.4156
VO.	0.4952	0.3969	VD	0.5080	0.4156
Y3	0.5016	0.4062	YB	0.5145	0.4249
1	0.4966	0.4062		0.5091	0.4249
	0.4952	0.3969		0.5080	0.4156
V4	0.5000	0.3969	V6	0.5132	0.4156
Y4	0.5066	0.4062	YC	0.5198	0.4249
	0.5016	0.4062		0.5145	0.4249
	0.4865	0.4062		0.4984	0.4250
Y5	0.4915	0.4062	YD	0.5038	0.4250
15	0.4976	0.4156	טז	0.5099	0.4344
	0.4925	0.4156		0.5044	0.4344
	0.4915	0.4062		0.5038	0.4250
V.C	0.4966	0.4062	VE	0.5091	0.4249
Y6	0.5028	0.4156	YE	0.5154	0.4343
	0.4976	0.4156		0.5099	0.4344
	0.4966	0.4062	T	0.5091	0.4249
V7	0.5016	0.4062	YF	0.5145	0.4249
Y7	0.508	0.4156		0.5209	0.4342
	0.5028	0.4156		0.5154	0.4343
	0.5016	0.4062		0.5145	0.4249
V0	0.5066	0.4062	8 8 8 8 8 8	0.5198	0.4249
Y8	0.5132	0.4156	YG	0.5264	0.4342
	0.5080	0.4156		0.5209	0.4342

Region	CIE x	CIE y	Region	CIE x	CIE y
	:	W rank	(2700 K)		
	0.4373	0.3893		0.4465	0.4071
1444	0.4418	0.3981	1440	0.4513	0.4164
W1	0.4475	0.3994	W9	0.4573	0.4178
	0.4428	0.3906		0.4523	0.4085
	0.4428	0.3906		0.4523	0.4085
W2	0.4475	0.3994	WA	0.4573	0.4178
VVZ	0.4532	0.4008	WA	0.4634	0.4193
	0.4483	0.3919		0.4582	0.4099
	0.4483	0.3919		0.4582	0.4099
W3	0.4532	0.4008	WB	0.4634	0.4193
VVS	0.4589	0.4021	VVB	0.4695	0.4207
	0.4538	0.3931		0.4641	0.4112
	0.4538	0.3931		0.4641	0.4112
W4	0.4589	0.4021	wc	0.4695	0.4207
VV-4	0.4646	0.4034	WC	0.4756	0.4221
	0.4593	0.3944		0.4700	0.4126
	0.4418	0.3981		0.4513	0.4164
W5	0.4465	0.4071	WD	0.4562	0.4260
VVJ	0.4523	0.4085	VVD	0.4624	0.4274
	0.4475	0.3994		0.4573	0.4178
	0.4475	0.3994		0.4573	0.4178
W6	0.4523	0.4085	WE	0.4624	0.4274
VVO	0.4582	0.4099	VV L	0.4687	0.4289
	0.4532	0.4008		0.4634	0.4193
	0.4532	0.4008		0.4634	0.4193
W7	0.4582	0.4099	WF	0.4687	0.4289
***	0.4641	0.4112		0.4750	0.4304
	0.4589	0.4021		0.4695	0.4207
	0.4589	0.4021		0.4695	0.4207
W8	0.4641	0.4112		0.4750	0.4304
v V O	0.4700	0.4126		0.4813	0.4319
	0.4646	0.4034		0.4756	0.4221

d) Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
V rank (3000 K)					
	0.4147	0.3814		0.4221	0.3984
\/4	0.4183	0.3898	. VO	0.4259	0.4073
V1	0.4242	0.3919	V9	0.4322	0.4096
	0.4203	0.3833		0.4281	0.4006
	0.4203	0.3833		0.4281	0.4006
V2	0.4242	0.3919		0.4322	0.4096
V2	0.4300	0.3939	VA	0.4385	0.4119
	0.4259	0.3853		0.4342	0.4028
	0.4259	0.3853		0.4342	0.4028
V2	0.4300	0.3939	VD	0.4385	0.4119
V3	0.4359	0.3960	VB	0.4449	0.4141
	0.4316	0.3873		0.4403	0.4049
	0.4316	0.3873		0.4403	0.4049
V4	0.4359	0.3960	VC	0.4449	0.4141
V4	0.4418	0.3981	VC	0.4513	0.4164
	0.4373	0.3893		0.4465	0.4071
	0.4183	0.3898		0.4259	0.4073
V5	0.4221	0.3984	VD	0.4299	0.4165
Vo	0.4281	0.4006	VD	0.4364	0.4188
	0.4242	0.3919	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	0.4322	0.4096
	0.4242	0.3919		0.4322	0.4096
VE	0.4281	0.4006	VE	0.4364	0.4188
V6	0.4342	0.4028	VE	0.4430	0.4212
	0.4300	0.3939		0.4385	0.4119
	0.4300	0.3939		0.4385	0.4119
V7	0.4342	0.4028	VF	0.4430	0.4212
٧/	0.4403	0.4049		0.4496	0.4236
	0.4359	0.3960		0.4449	0.4141
	0.4359	0.3960		0.4449	0.4141
V8	0.4403	0.4049		0.4496	0.4236
٧ŏ	0.4465	0.4071	VG	0.4562	0.4260
	0.4418	0.3981	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	0.4513	0.4164

Region	CIE x	CIE y	Region	CIE x	CIE y
		U rank	(3500 K)		
	0.3889	0.3690		0.3941	0.3848
114	0.3915	0.3768	110	0.3968	0.3930
U1	0.3981	0.3800	U9	0.4040	0.3966
	0.3953	0.3720	-	0.4010	0.3882
	0.3953	0.3720		0.4010	0.3882
	0.3981	0.3800		0.4040	0.3966
U2	0.4048	0.3832	UA	0.4113	0.4001
	0.4017	0.3751	-	0.4080	0.3916
	0.4017	0.3751		0.4080	0.3916
	0.4048	0.3832	110	0.4113	0.4001
U3	0.4116	0.3865	UB	0.4186	0.4037
	0.4082	0.3782		0.4150	0.3950
	0.4082	0.3782		0.4150	0.3950
	0.4116	0.3865	110	0.4186	0.4037
U4	0.4183	0.3898	UC	0.4259	0.4073
	0.4147	0.3814		0.4221	0.3984
	0.3915	0.3768		0.3968	0.3930
lue.	0.3941	0.3848		0.3996	0.4015
U5	0.4010	0.3882	UD	0.4071	0.4052
	0.3981	0.3800		0.4040	0.3966
	0.3981	0.3800		0.4040	0.3966
116	0.4010	0.3882	ПЕ	0.4071	0.4052
U6	0.4080	0.3916	UE	0.4146	0.4089
	0.4048	0.3832		0.4113	0.4001
	0.4048	0.3832		0.4113	0.4001
117	0.4080	0.3916	UF	0.4146	0.4089
U7	0.4150	0.3950		0.4222	0.4127
	0.4116	0.3865		0.4186	0.4037
	0.4116	0.3865		0.4186	0.4037
110	0.4150	0.3950	ll C	0.4222	0.4127
U8	0.4221	0.3984	UG	0.4299	0.4165
	0.4183	0.3898		0.4259	0.4073

d) Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y	
	T rank (4000 K)					
	0.3670	0.3578		0.3702	0.3722	
	0.3726	0.3612		0.3763	0.3760	
T1	0.3744	0.3685	Т9	0.3782	0.3837	
	0.3686	0.3649		0.3719	0.3797	
	0.3726	0.3612		0.3763	0.3760	
	0.3783	0.3646		0.3825	0.3798	
T2	0.3804	0.3721	TA	0.3847	0.3877	
	0.3744	0.3685		0.3782	0.3837	
	0.3783	0.3646		0.3825	0.3798	
	0.3840	0.3681		0.3887	0.3836	
Т3	0.3863	0.3758	ТВ	0.3912	0.3917	
	0.3804	0.3721		0.3847	0.3877	
	0.3840	0.3681		0.3887	0.3837	
	0.3898	0.3716		0.3950	0.3875	
T4	0.3924	0.3794	TC	0.3978	0.3958	
	0.3863	0.3758		0.3912	0.3917	
	0.3686	0.3649		0.3719	0.3797	
T E	0.3744	0.3685	T D	0.3782	0.3837	
T5	0.3763	0.3760	TD	0.3802	0.3916	
	0.3702	0.3722		0.3736	0.3874	
	0.3744	0.3685		0.3782	0.3837	
TC	0.3804	0.3721	T C	0.3847	0.3877	
T6	0.3825	0.3798	TE	0.3869	0.3958	
	0.3763	0.3760		0.3802	0.3916	
	0.3804	0.3721		0.3847	0.3877	
T-7	0.3863	0.3758	TF	0.3912	0.3917	
T7	0.3887	0.3836		0.3937	0.4001	
	0.3825	0.3798		0.3869	0.3958	
	0.3863	0.3758		0.3912	0.3917	
то	0.3924	0.3794	TC	0.3978	0.3958	
Т8	0.3950	0.3875	TG	0.4006	0.4044	
	0.3887	0.3836		0.3937	0.4001	

d) Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region
Rr	ank (5000) к)	QR
	0.3371	0.3490	
R1	0.3451	0.3554	Q2
VI	0.344	0.3427	Q2
	0.3366	0.3369	
1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	0.3451	0.3554	
R2	0.3533	0.3620	R1
I\Z	0.3515	0.3487	KI
	0.3440	0.3427	
	0.3376	0.3616	
R3	0.3463	0.3687	Q4
NЭ	0.3451	0.3554	Q4
	0.3371	0.349	
1 1 2 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	0.3463	0.3687	
R4	0.3551	0.3760	R3
K4	0.3533	0.3620	K3
	0.3451	0.3554	

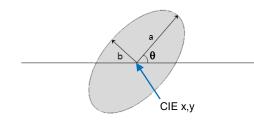
Region	CIE x	CIE y
QR	rank (530	00 K)
	0.3290	0.3417
03	0.3371	0.3490
Q2	0.3366	0.3369
	0.3290	0.3300
	0.3371	0.3490
D1	0.3451	0.3554
R1	0.3440	0.3427
	0.3366	0.3369
	0.3290	0.3538
Q4	0.3376	0.3616
Q4	0.3371	0.3490
	0.3290	0.3417
	0.3376	0.3616
R3	0.3463	0.3687
	0.3451	0.3554
	0.3371	0.3490

Region	CIE x	CIE y	Re
Qr	ank (5700) к)	
	0.3215	0.3350	
01	0.3290	0.3417	,
QI	0.3290	0.330	ľ
	0.3222	0.3243	
	0.3290	0.3417	
Q2	0.3371	0.3490	
QΖ	0.3366	0.3369	
	0.3290	0.3300	
	0.3207	0.3462	
Q3	0.3290	0.3538	
ŲS	0.3290	0.3417	'
	0.3215	0.3350	
	0.3290	0.3538	
Q4	0.3376	0.3616	
	0.3371	0.3490	(
	0.3290	0.3417	

Region	CIE x	CIE y
PQ	rank (600	0 K)
	0.3144	0.3186
P2	0.3221	0.3261
PZ	0.3213	0.3373
	0.3130	0.3290
	0.3215	0.335
01	0.3290	0.3417
Q1	0.3290	0.3300
	0.3222	0.3243
	0.3130	0.3290
P4	0.3213	0.3373
P4	0.3205	0.3481
	0.3115	0.3391
	0.3207	0.3462
Q3	0.3290	0.3538
	0.3290	0.3417
	0.3215	0.3350

Region	CIE x	CIE y		
Pr	P rank (6500 K)			
P1	0.3068	0.3113		
	0.3144	0.3186		
	0.3130	0.329		
	0.3048	0.3207		
P2	0.3144	0.3186		
	0.3221	0.3261		
	0.3213	0.3373		
	0.3130	0.3290		
	0.3048	0.3207		
P3	0.3130	0.3290		
Р3	0.3115	0.3391		
	0.3028	0.3304		
P4	0.3130	0.3290		
	0.3213	0.3373		
	0.3205	0.3481		
	0.3115	0.3391		

e) MacAdam Ellipse ($I_F = 350 \text{ mA}, T_j = 85 \text{ }^{\circ}\text{C}$)



Nom. CCT Color	Ellipse	Center		Rotation		b	
(K)	(K) Rank	Ellibse	CIE x	CIE y	Angle θ (°)		D
2200	YM	3-step	0.5018	0.4153	53.45	0.0072	0.0040
2700	WM	3-step	0.4578	0.4101	53.70	0.0081	0.0042
3000	VM	3-step	0.4338	0.4030	53.22	0.0083	0.0041
3500	UM	3-step	0.4073	0.3917	54.00	0.0093	0.0041
4000	TM	3-step	0.3818	0.3797	53.72	0.0094	0.0040
5000	RN	5-step	0.3447	0.3553	59.62	0.0137	0.0059
5700	QN	5-step	0.3287	0.3417	59.10	0.0125	0.0053
6500	PN	5-step	0.3123	0.3282	58.57	0.0116	0.0048

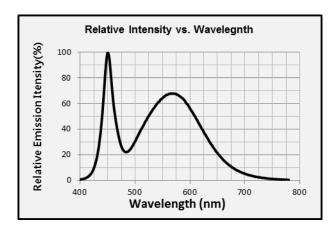
Note:

Samsung maintains measurement tolerance of: Cx, $Cy = \pm 0.005$

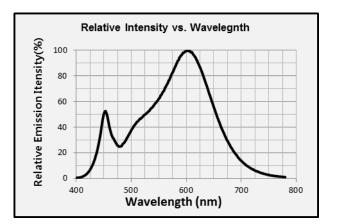
3. Typical Characteristics Graphs

a) Spectrum Distribution ($I_F = 350$ mA, $T_j = 85$ $^{\circ}$ C)

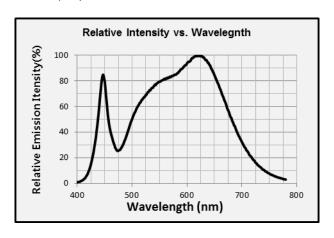
Cool White (CRI70)



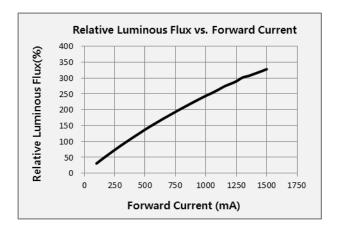
Warm White (CRI80)

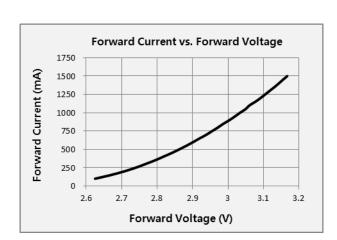


Warm White (CRI90)

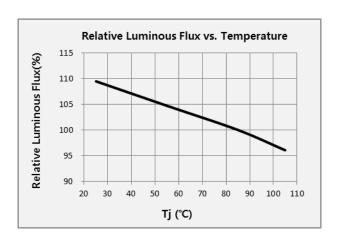


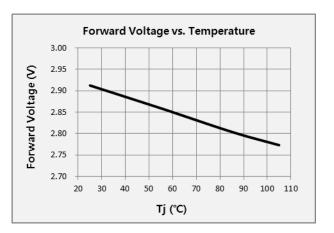
b) Forward Current Characteristics (T_j = 85 °C)



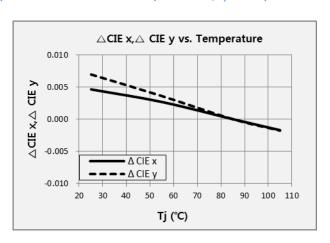


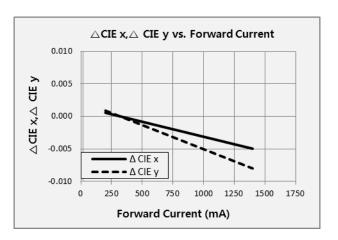
c) Temperature Characteristics (I_F = 350 mA)



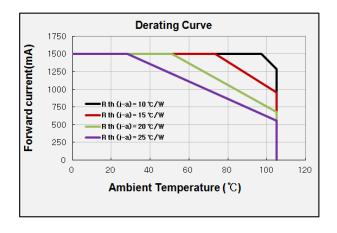


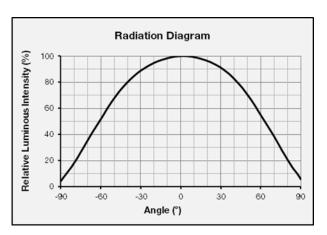
d) Color Shift Characteristics (I_F = 350 mA, T_j = 85 $^{\circ}$ C)



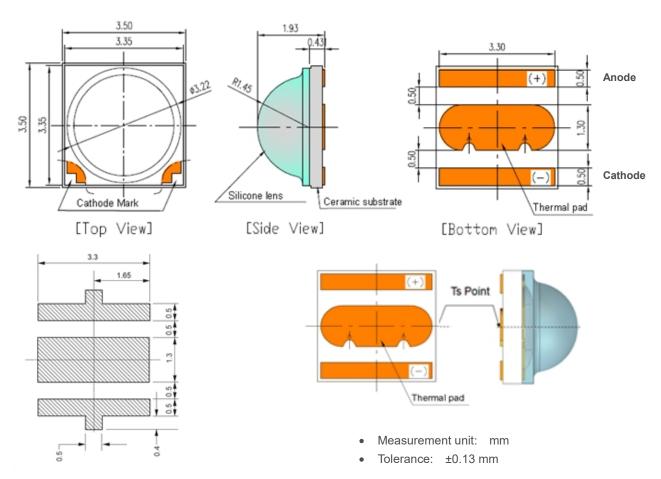


e) Derating Curve and Beam Angle Characteristics (I_F = 350 mA, T_j = 25 °C)





4. Outline Drawing & Dimension



Recommended Soldering Pattern

Notes:

- 1) This LED has built-in ESD protection device(s) connected in parallel to LED chip(s).
- 2) The thermal pad is electrically isolated from the anode and cathode contact pads.
- 3) T_s point and measurement method:
 - ① Measure the nearest point to thermal pad as shown above. If necessary, remove PSR of PCB to reach T₅ point.
 - ② All pads must be soldered to the PCB to dissipate heat properly, otherwise the LED can be damaged.

Precautions:

- 1) Pressure on the LEDs will influence to the reliability of the LEDs. Precautions should be taken to avoid strong pressure on the LEDs. Do not put stress on the LEDs during heating.
- 2) Re-soldering should not be done after the LEDs have been soldered. If re-soldering is unavoidable, LED's characteristics should be carefully checked before and after such repair.
- 3) Do not stack assembled PCBs together. Since materials of LEDs is soft, abrasion between two PCB assembled with LED might cause catastrophic failure of the LEDs.

5. Reliability Test Items & Conditions

a) Test Items

Test Item	Test Condition	Test Hour / Cycle
Room Temperature Life Test	25 °C, , Maximum Rated Drive Current	1000 h
High Temperature Life Test	85 ºC, , Maximum Rated Drive Current	1000 h
High Temperature Humidity Life Test	85 °C, 85 % RH, , Maximum Rated Drive Current	1000 h
Low Temperature Life Test	-40 °C, , Maximum Rated Drive Current	1000 h
Damp Heat Cycling	-10 $^{\circ}$ C \leftrightarrow 25 $^{\circ}$ C 95 % RH \leftrightarrow 65 $^{\circ}$ C 95 % RH , Maximum Rated Drive Current, 24 h / 1 cycle	10 cycles
Powered Temperature Cycle	-40 °C / 85 °C each 20 min, 100 min transfer power on/off each 5 min, , Maximum Rated Drive Current	100 cycles
Temperature Cycling	-45 $^{ m eC}$ / 15 min \leftrightarrow 125 $^{ m eC}$ / 15 min temperature change within 5 min	500 cycles
High Temperature Storage	120 ºC	1000 h
Low Temperature Storage	-40 ºC	1000 h
ESD (HBM)	R_{1} : $10 M\Omega$ R_{2} : $1.5 k\Omega$ C : $100 pF$ V : $\pm 8 kV$	5 times
ESD (MM)	R_{1} : $10M\Omega$ R_{2} : 0 C : $200pF$ V : $\pm 0.5kV$	5 times
Vibration Test	20~2000~20 Hz, 200 m/s², sweep 4 min X, Y, Z 3 direction, each 1 cycle	4 cycles
Mechanical Shock Test	1500 g, 0.5 ms 3 shocks each X-Y-Z axis	5 cycles

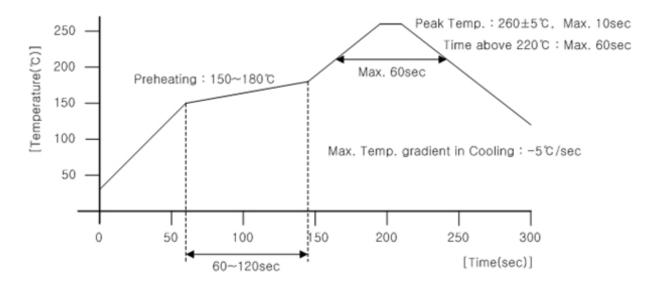
b) Criteria for Judging the Damage

Item	Symbol	Test Condition	Lin	Limit		
	Зуппон	(T _j = 25 ºC)	Min.	Max.		
Forward Voltage	V_{F}	I _F = 350 mA	Init. Value * 0.9	Init. Value * 1.1		
Luminous Flux	Φν	I _F = 350 mA	Init. Value * 0.7	Init. Value * 1.1		

6. Soldering Conditions

a) Reflow Conditions (Pb free)

Reflow frequency: 2 times max.



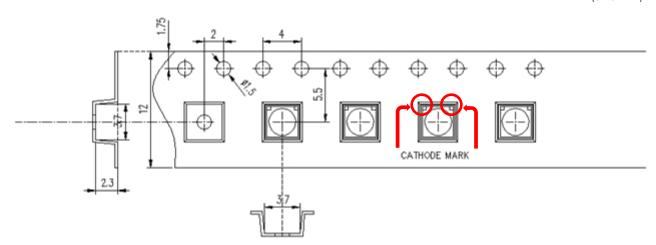
b) Manual Soldering Conditions

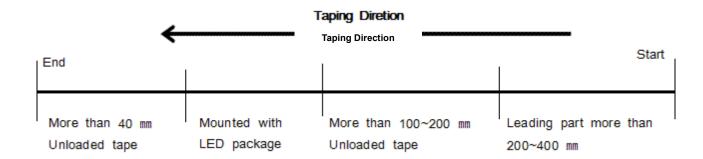
Not more than 5 seconds @ max. 300 °C, under soldering iron.

7. Tape & Reel

a) Taping Dimension

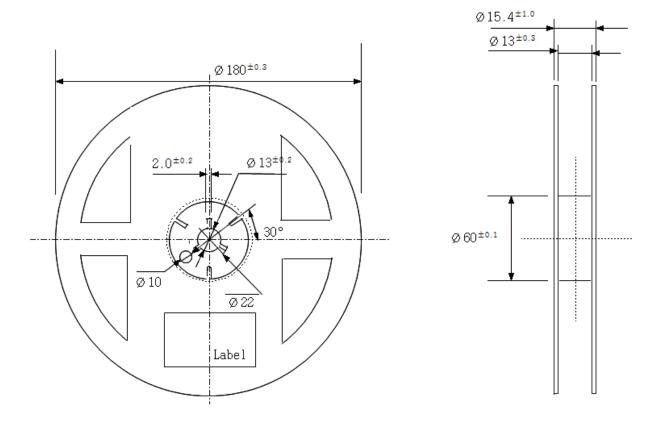
(unit: mm)





b) Reel Dimension

(unit: mm)

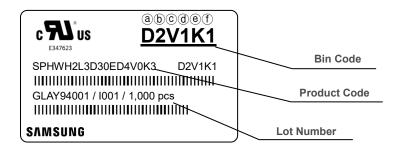


Notes:

- 1) Quantity: The quantity/reel is 1,000 pcs
- 2) Cumulative tolerance: Cumulative tolerance / 10 pitches is ± 0.2 mm
- 3) Adhesion strength of cover tape: Adhesion strength is 0.1-0.7 N when the cover tape is turned off from the carrier tape at 10° angle to the carrier tape
- 4) Packaging: P/N, Manufacturing data code no. and quantity are indicated on the aluminum packing bag

8. Label Structure

a) Label Structure



Note: Denoted bin code and product code above is only an example (see description on page 7)

Bin Code:

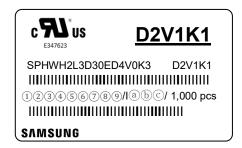
(a) (b): Forward Voltage bin (refer to page 15)

© d: Chromaticity bin (refer to page 16-19)

(refer to page 8-11)

b) Lot Number

The lot number is composed of the following characters:



123456789/labc /1,000 pcs

①, ② : Production site (GL: Tianjin, China, GB: Nanchang, China)

3 : Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)

(Y: 2014, Z: 2015, A: 2016, B: 2017, C: 2018, D: 2019 ...)

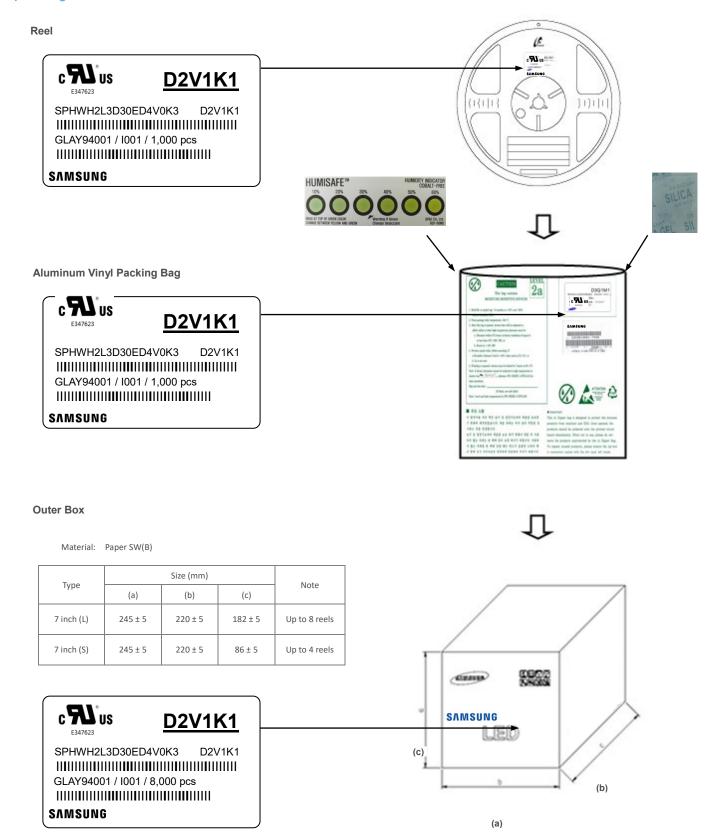
(5) : Month (1~9, A, B, C)(6) : Day (1~9, A, B~V)

789: Product serial number $(001 \sim 999)$

(a)b)C : Reel number (001 ~ 999)

9. Packing Structure

a) Packing Process



b) Aluminum Vinyl Packing Bag



CAUTION

2a

This bag contains MOISTURE SENSITIVE DEVICES

- Shelf life in sealed bag: 12 months at <40°C and <90% relative humidity (RH)
- 2. Peak package body temperature: 240 °C
- After this bag is opened, devices that will be subjected to reflow solder or other high temperature processes must be:
 - a. Mounted within 672 hours at factory conditions of equal to or less than 30°C /60% RH, or
 - b. Stored at < 10% RH
- Devices require bake, before mounting, if:
 a.Humidity Indicator Card is > 65% when read at 23±5°C, or
 b. 2a is not met.
- 5. If baking is required, devices must be baked for 1 hours at 60±5°C Note: if device containers cannot be subjected to high temperature or shorter bake times are desired, reference IPC/JEDEC J-STD-033 for bake procedure.

Bag seal due date: .

(if blank, see code label)

Note: Level and body temperature by IPC/JEDEC J-STD-020

Cone HE

c**Al**us

SAMSUNG

SPHWH2L3D30ED4V0K3

GLAY94001 / I001 / 1,000 pcs





D2V1K1



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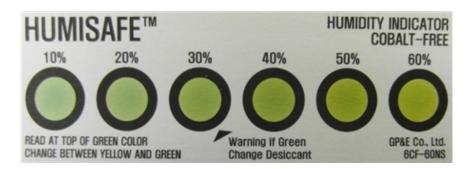
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■ Important

This Al Zipper bag is designed to protect the enclosed products from moisture and ESD. Once opened, the products should be soldered onto the printed circuit board immediately. When not in use, please do not leave the products unprotected by the Al Zipper Bag. To repack unused products, please ensure the zip-lock is completely sealed with the dry pack left inside.

c) Silica Gel & Humidity Indicator Card inside Aluminum Vinyl Bag





10. Precautions in Handling & Use

- 1) For over-current protection, users are recommended to apply resistors connected in series with the LEDs to mitigate sudden change of the forward current caused by shift of forward voltage.
- 2) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the device.
- 3) When the device is in operation, the forward current should be carefully determined considering the maximum ambient temperature and corresponding junction temperature.
- 4) LEDs must be stored in a clean environment. If the LEDs are to be stored for three months or more after being shipped from Samsung, they should be packed with a nitrogen-filled container (shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH).
- 5) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
 - a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 ºC / 60 % RH, or
 - b. Stored at <10 % RH
- 6) Repack unused devices with anti-moisture packing, fold to close any opening and then store in a dry place.
- 7) Devices require baking before mounting, if humidity card reading is >60 % at $23 \pm 5 \degree C$.
- 8) Devices must be baked for 1 hour at 60 ± 5 °C, if baking is required.
- 9) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.

Legal and additional information.

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We are also leading in the Internet of Things space through, among others, our Digital Health and Smart Home initiatives. We employ 307,000 people across 84 countries. To discover more, please visit our official website at www.samsung.com and our official blog at global.samsungtomorrow.com.

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